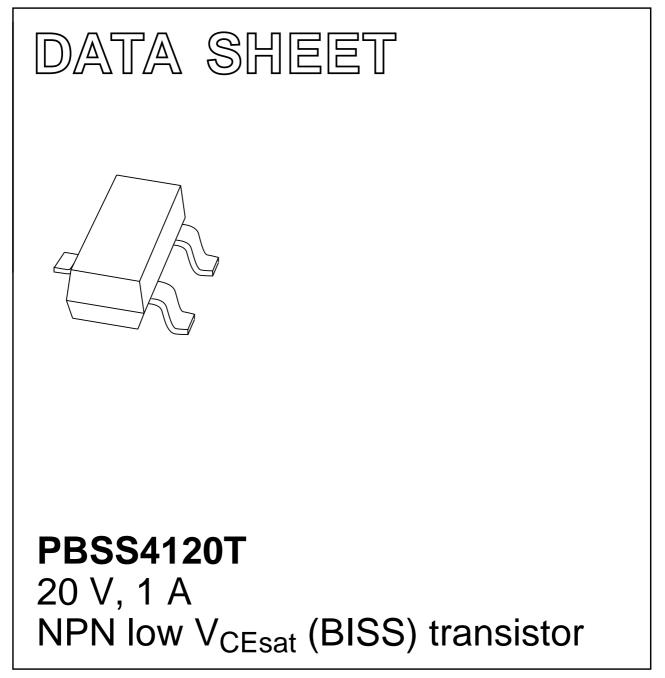
### DISCRETE SEMICONDUCTORS



Product specification

2003 Sep 29



### 20 V, 1 A NPN low V<sub>CEsat</sub> (BISS) transistor

#### FEATURES

- Low collector-emitter saturation voltage V<sub>CEsat</sub>
- High collector current capability  $I_C$  and  $I_{CM}$
- High efficiency leading to less heat generation
- Reduced printed-circuit board requirements
- Cost effective alternative to MOSFETs in specific applications.

#### **APPLICATIONS**

- · Power management
  - DC/DC conversion
  - Supply line switching
  - Battery charger
  - LCD backlighting.
- Peripheral driver
  - Driver in low supply voltage applications (e.g. lamps and LEDs)
  - Inductive load drivers (e.g. relays, buzzers and motors).

#### DESCRIPTION

NPN BISS transistor in a SOT23 plastic package providing ultra low  $V_{CEsat}$  and  $R_{CEsat}$  parameters. PNP complement: PBSS5120T.

#### MARKING

2003 Sep 29

TYPE NUMBER	MARKING CODE <sup>(1)</sup>		
PBSS4120T	*3B		

#### Note

- 1. \* = p: made in Hong Kong.
- \* = t: made in Malaysia.
  - \* = W: made in China.

#### **ORDERING INFORMATION**

#### QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT	
V <sub>CEO</sub>	collector-emitter voltage	20	V	
I <sub>C</sub>	collector current (DC)	1	А	
I <sub>CM</sub>	peak collector current	3	А	
R <sub>CEsat</sub>	equivalent on-resistance	200	mΩ	

#### PINNING

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	

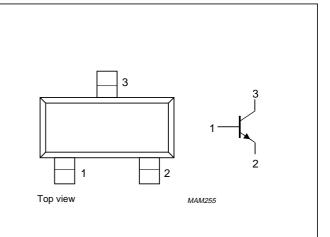


Fig.1 Simplified outline (SOT23) and symbol.

TYPE NUMBER		PACKAGE			
	NAME	NAME DESCRIPTION VEI			
PBSS4120T	_	plastic surface mounted package; 3 leads	SOT23		

#### PBSS4120T

## 20 V, 1 A NPN low $V_{CEsat}$ (BISS) transistor

### PBSS4120T

#### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	-	30	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	20	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	5	V
I <sub>C</sub>	collector current (DC)		-	1	A
I <sub>CM</sub>	peak collector current		-	3	A
I <sub>BM</sub>	peak base current		-	300	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C;$ note 1	-	300	mW
		$T_{amb} \le 25 \ ^{\circ}C$ ; note 2	-	480	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C

#### Notes

- 1. Device mounted on a FR4 printed-circuit board, single-sided copper, tinplated, standard footprint.
- 2. Device mounted on a FR4 printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm<sup>2</sup>.

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	in free air; note 1	417	K/W
		in free air; note 2	260	K/W

#### Notes

- 1. Device mounted on a FR4 printed-circuit board, single-sided copper, tinplated, standard footprint.
- 2. Device mounted on a FR4 printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm<sup>2</sup>.

## 20 V, 1 A NPN low $V_{CEsat}$ (BISS) transistor

### PBSS4120T

#### CHARACTERISTICS

 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = 30 \text{ V}; I_E = 0$	-	-	100	nA
		$V_{CB} = 30 \text{ V}; \text{ I}_{E} = 0; \text{ T}_{j} = 150 ^{\circ}\text{C}$	-	-	50	μA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 4 V; I_{C} = 0$	-	-	100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = 2 \text{ V}; I_{C} = 100 \text{ mA}$	350	470	_	
		$V_{CE} = 2 \text{ V}; \text{ I}_{C} = 500 \text{ mA}$	300	450	-	
		$V_{CE} = 2 \text{ V}; \text{ I}_{C} = 1 \text{ A}$	280	420	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_{\rm C} = 100 \text{ mA}; I_{\rm B} = 1 \text{ mA}$	-	-	80	mV
		$I_{\rm C} = 500 \text{ mA}; I_{\rm B} = 50 \text{ mA}$	-	-	110	mV
		I <sub>C</sub> = 750 mA; I <sub>B</sub> = 15 mA	-	-	200	mV
		$I_{C} = 1 \text{ A}; I_{B} = 50 \text{ mA}; \text{ note } 1$	-	-	250	mV
R <sub>CEsat</sub>	equivalent on-resistance	$I_{C} = 500 \text{ mA}; I_{B} = 50 \text{ mA}; \text{ note } 1$	_	-	220	mΩ
V <sub>BEsat</sub>	base-emitter saturation voltage	$I_{\rm C} = 1 \text{ A}; I_{\rm B} = 100 \text{ mA}; \text{ note } 1$	-	-	1.1	V
V <sub>BEon</sub>	base-emitter turn-on voltage	$V_{CE} = 2 \text{ V}; I_{C} = 100 \text{ mA}$	-	-	0.75	V
f <sub>T</sub>	transition frequency	I <sub>C</sub> = 100 mA; V <sub>CE</sub> = 10 V; f = 100 MHz	100	-	-	MHz
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0;$ f = 1 MHz	-	-	20	pF

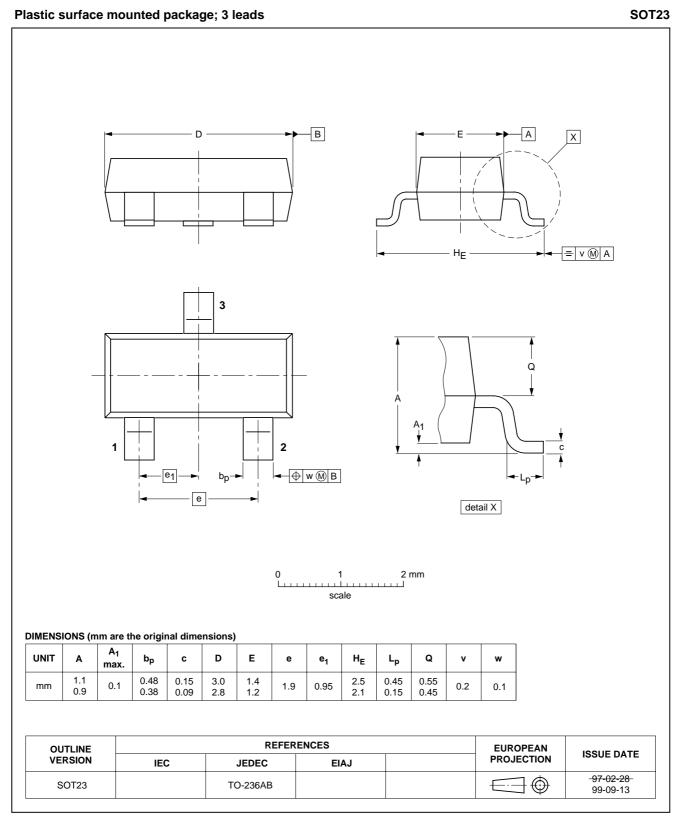
#### Note

1. Pulse test:  $t_p \leq 300 \ \mu s; \ \delta \leq 0.02.$ 

PBSS4120T

## 20 V, 1 A NPN low $V_{CEsat}$ (BISS) transistor

#### PACKAGE OUTLINE



# 20 V, 1 A NPN low $V_{CEsat}$ (BISS) transistor

PBSS4120T

#### DATA SHEET STATUS

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)(3)</sup>	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
11	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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